



Customer Information Notification

202601009I : PCF8563 Datasheet Update

Note: This notice is NXP Company Proprietary.

Issue Date: Jun 12, 2026 Effective Date: Jun 15, 2026

Dear Emma Tempest,

Here is your personalized communication about an NXP notification.
For detailed information we invite you to [view this notification online](#)

Management summary

NXP Semiconductor announces a PCF8563 datasheet update

Change Category

☐ Wafer Fab Process	☐ Assembly Process	☐ Product Marking	☐ Test Process	☐ Design
☐ Wafer Fab Materials	☐ Assembly Materials	☐ Mechanical Specification	☐ Test Equipment	☐ Errata
☐ Wafer Fab Location	☐ Assembly Location	☐ Packing/Shipping/Labeling	☐ Test Location	☐ Electrical spec./Test coverage

☐ Firmware ☒ Other: Datasheet

Notification Overview

Description

PCF8563 Rev. 11.1: <https://www.nxp.com/docs/en/data-sheet/PCF8563.pdf>

Replacement parts from the Table 1 were updated.

Reason

The earlier replacement parts are now End-of-Life (EOL) and no longer suitable for recommendation. The update introduces a more appropriate and current replacement option.

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

A new data sheet will be issued

Additional information

Additional documents: [view online](#)

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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